

# **Audio Interface ICs for Digital Cameras and Camcorders**

# 1.1W to 1.5W



# **Monaural Speaker Amplifiers**

# BH7824FVM,BH7826FVM

No.15090EBT01

## Description

The BH7824FVM and BH7826FVM are speaker amplifier ICs for low-voltage drives and low power consumption audio, specialized for mobile telephones and other mobile audio devices.

#### Features

- 1) BTL monaural speaker amplifier
- 2) Capable of high power 500mW/8Ω/BTL output
- 3) Wide power supply voltage range
- 4) Supports active/shutdown modes
- 5) Built-in anti-pop circuit
- 6) Built-in thermal shutdown circuit

## Applications

Mobile telephones, PDAs, notebook computers, DSC, DVC, and other mobile audio devices.

# Product lineup

Part No. BH7824FVM		BH7826FVM
Input type	Unbalanced input	Balanced input
Supply voltage(V)	2.4 ~ 5.5	2.6 ~ 5.5

#### Absolute maximum ratings(Ta=25°C)

Parameter	Symbol	Limits	Unit
Supply voltage	V <sub>CC</sub> max.	6.0	V
Power dissipation	Pd	470(*1)	mW
Operating temperature	Topr	-30 ~ +85(*2)	°C
Storage temperature	Tstg	-55 ~ +125	°C

<sup>1</sup> Reduced by 4.7 mW/°C at 25°C or higher, when mounted on a 70mm×70mm×1.6mm PCB board.

<sup>\*2</sup> Topr=70°C ~ 85°C is the range for performing basic operations and does not guarantee characteristics or rated output. Moreover, TSD (Thermal Shutdown) may become operable if input signals occurring in this range are excessive.

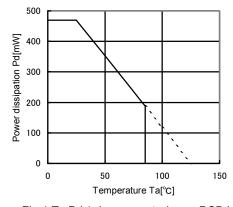


Fig.1 Ta-Pd (when mounted on a PCB board)

●Operating conditions (Ta=25°C)

Devementer	Ratings		
Parameter	BH7824FVM	BH7826FVM	
Supply voltage	2.4V ~ 5.5V	2.6 ~ 5.5	

<sup>\*</sup> Note: This IC is not designed to be radiation-resistant.

●Electrical characteristics (Unless otherwise noted Ta=25°C, Vcc=3.6V, f=1kHz, RL=8Ω)

ectrical characteristics (Unless otherwise noted 1a=25°C, VCC=3.6V, T=1KHZ, RL=8Ω)					
Parameter	Symbol	Limits(Typ.)		Unit	Conditions
Farameter	Symbol	BA7824FVM	BA7826FVM	Offic	Conditions
Circuit current 1	I <sub>CC1</sub>	3.5	3.5	mA	No signal , Active mode
Circuit current 2	I <sub>CC2</sub>	0	0	μA	No signal, Suspend mode
Voltage gain 1	G <sub>V1</sub>	+11.5	+11.5	dB	V <sub>IN</sub> =-20dBV,1st Op-amp gain
Voltage gain 2	G <sub>V2</sub>	0	_	dB	2nd Op-amp gain
Maximum output voltage1	V <sub>OM1</sub>	+6.0	+6.0	dBV	DSTN=1% ,BTL *1
Maximum output voltage2	V <sub>OM2</sub>	_	+5.1	dBV	V <sub>CC</sub> =3.4V,DSTN=1%,BTL <sup>*1</sup>
Output distortion	D <sub>STN</sub>	0.07	0.2	%	V <sub>IN</sub> =-20dB,V SE *1
Output noise level	V <sub>NO</sub>	-94	-94	dBV	No signal, SE Active mode *2
Suspend attenuation	Gs	-107	-107	dBV	V <sub>IN</sub> =-20dB,V BTL *2
Bias setting voltage	V <sub>BIAS</sub>	1.8	1.8	V	3pin DC voltage
Suspend hold voltage / H	V <sub>SH1</sub>	V <sub>CC</sub> × 0.8 ~ V <sub>CC</sub>	2.0 ~ V <sub>CC</sub>	V	Active mode, Hold voltage
Suspend hold voltage / L	V <sub>SH2</sub>	0 ~ 0.5	0 ~ 0.5	V	Suspend mode, Hold voltage

<sup>\*1 :</sup> B.W.=0.4 ~ 30kHz \*2 : DIN AUDIO

# Measurement circuit

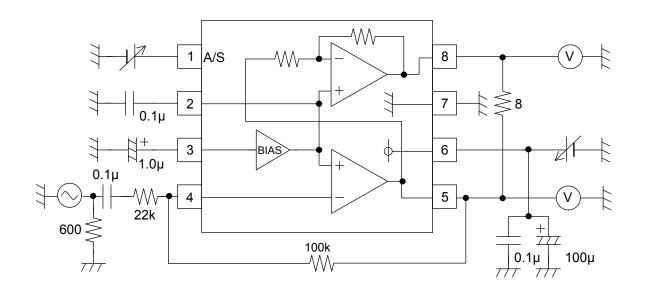


Fig.2 BH7824FVM

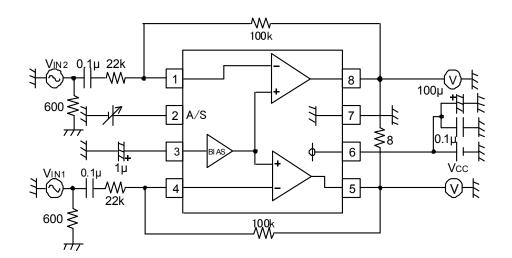


Fig.3 BH7826FVM

# ●Block diagram

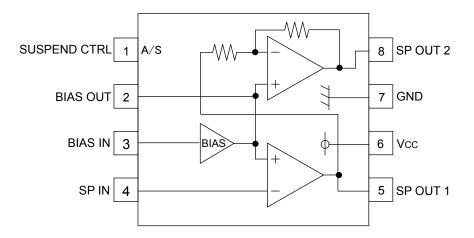


Fig.4 BH7824FVM

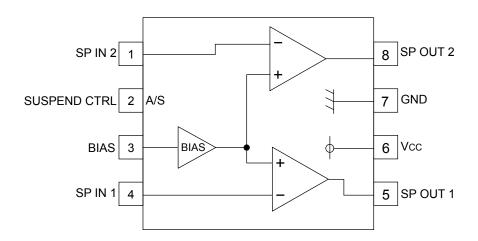


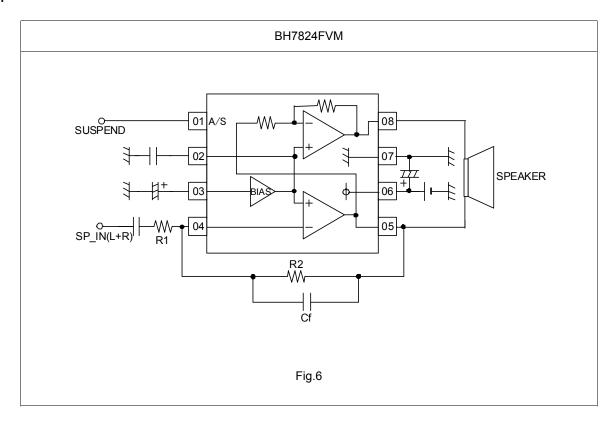
Fig.5 BH7826FVM

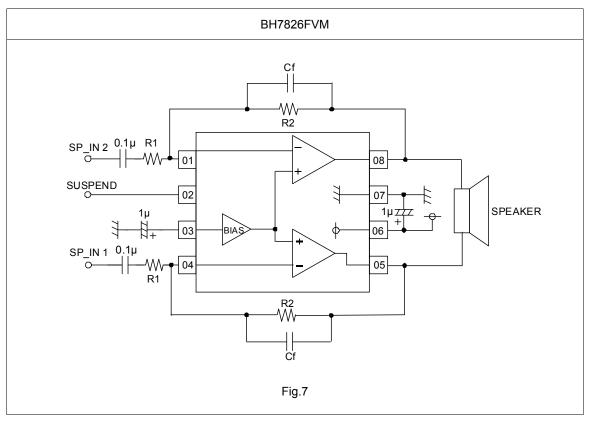
# ●Equivalent circuit

Pin	ВН	17824FVM	BH7826FVM		
No.	Pin name	Equivalent circuit	Pin name	Equivalent circuit	
1	SUSPEND CTRL	01 \$50k	SP IN2	1k-01	
2	BIAS OUT	\$ 30k 487k 02	SUSPEND CTRL	02	
3	BIAS IN	30k 57k 03	BIAS IN	\$30k 150k	
4	SP IN	1k 04	SP IN1		
5	SP OUT1	05	SP OUT1	05	
6	Vcc	_	Vcc	_	
7	GND	_	GND	_	
8	SP OUT2	08	SP OUT2	08	

Note: Numerical values in figures are design values, and do not guarantee ratings.

# Application circuit





# • Functions and Settings of external components

#### [Function of external components]

①R1

R1 is an input resistor of inverting amplifier which determines closed loop gain with R2.

(2)R2

R2 is a feedback resistor of inverting amplifier determine closed loop gain with R2. The gain is set by below expression.

$$\text{Gain(BTL)=20log}_{10} \Bigg\{ \frac{\text{R2}}{\text{R1}} \times \frac{1}{\text{K}_0 + \text{K}_1 \times \left(1 + \frac{\text{R2}}{\text{R1}}\right) + \text{K}_2 \times \text{R2}}} \Bigg\}$$

$$\%$$
 K<sub>0</sub> , K<sub>1</sub>, K<sub>2</sub> are constants (Values below are reference values and not guaranteed values)   
 K<sub>0</sub> = 0.48 , K<sub>1</sub>= 6.96 × 10<sup>-3</sup> , K<sub>2</sub> = 4.36 × 10<sup>-7</sup>

The expression above is a conversion formula to be checked and adjusted for the actual equipment.

(3)Cf

Cf is feedback capacitor to cut high frequency signals.

It forms a low-pass filter with R2. The cut-off frequency is calculated as below.

$$f_{cL} = 1$$
 [Hz]  $2\pi \times R2 \times Cf$ 

(注) R1,R2,Cf and fcL has limits in below table. Please set these component values in the ranges.

	Ranges		
R1	10kΩ ≦ R1 ≦120kΩ		
R2	$47k\Omega \le R2 \le 120k\Omega$		
Cf	Gain>+6dB Cf≦560pF		
CI	0 <gain≦+6db< td=""><td>Cf≦270pF</td></gain≦+6db<>	Cf≦270pF	
fcL	fcL ≧ 4kHz		

# 4 Cb1 (Cb2 is only BH7824FVM.)

The capacitors stabilize DC bias voltage.

	BH7824FVM	BH7826FVM
Cb1	1µF	1µF
Cb2	0.1µF	_

As Cb1 (or Cb2) becomes larger, power supply rejection ratio is improved but turn on time becomes longer. As it becomes smaller, turn on time becomes shorter but power supply rejection ratio and cross talk become worse.

# ⑤Cin

It is Input coupling capacitor.

The value of the input capacitor directly affects the low frequency performance of the circuit.

The corner frequency of the high pass filter is determined in equation at ③ of next section.

# [Configuration of external components ]

1 Gain

Gain is designed by output power application ask for. Output power is determined to below.

Po[W] = Vo<sup>2</sup>[Vrms] / RL[
$$\Omega$$
]  
Vo = Gv · Vin  
Gv  $\ge \sqrt{\text{Po} \cdot \text{RL}}$  / Vin

② Values of R1 and R2

R1 and R2 are determined to Av.

 $Av = (R2/R1) \times 2$ 

Input impedance (R1) must be probable driven by signal source

3 Input coupling capacitor

Corner frequency of HPF is determined in below.

 $fc[Hz] = 1 / (2\pi \cdot R1 \cdot Cin)$ 

Input coupling is solved by equation of fc.

Cin  $\geq$  1 / (2 $\pi$  · R1 · fc)

# [instruction for use carefully]

①Do not connect capacitive load has more than below capacitance between OUT1,2(5,8pin) and GND otherwise oscillation may occured.

	8, 12 Ω Speakers	16Ωspeaker
	BH7824FVM / 26FVM	BH7824FVM
Co	Co ≦ 100pF	Co ≦ 47pF

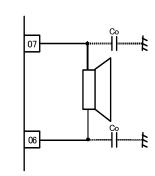


Fig.8 Output connections

- 2Do not use this IC without a load.
- ③This IC is compatible with dynamic speaker loads ( $8\sim40\,\Omega$  : BH7824FVM、 $8\sim12\,\Omega$  : BH7826FVM) and is not compatible with loads other than these mentioned.
- ④soft mute setting becomes effective on connecting a resistor and capacitor to the SUSPEND pin (1pin: BH7824FVM, 2pin: BH7826FVM).

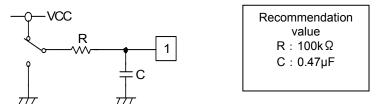


Fig.9 BH7824FVM application circuit for soft mute

⑤Place the Vcc decoupling capacitor between VCC(6pin) and GND(7pin) as close to IC as possible.

# ●Typical characteristics(BH7824FVM)

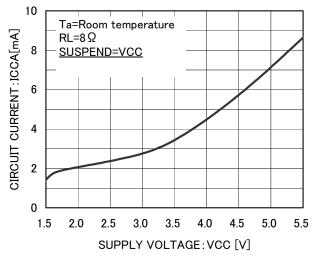
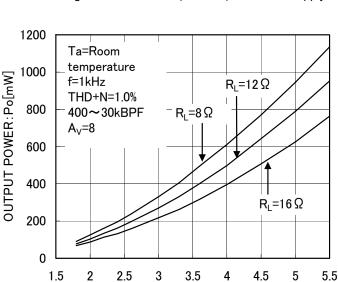


Fig.11 Circuit current (ACTIVE) — Power supply



SUPPLY VOLTAGE: VCC[V]

Fig.13 Output power — Power supply

350 300 POWER DISSIPATION: P<sub>D</sub> [mW] 250  $R_1 = 8 \Omega$ 200 Ta=Room 150 temperature VCC=3.6V  $R_L=16\Omega$ 100 f=1kHz 400~30kBPF 50 THD+N≤1.0% 0

200

Fig.15 Power dissipation — Outpu power

400

500

600

300

OUTPUT POWER: Po[mW]

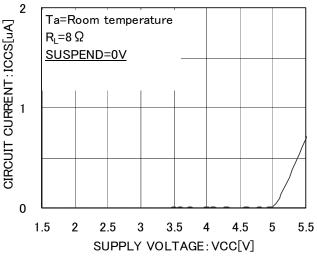


Fig.12 Circuit current (SUSPEND) — Power supply

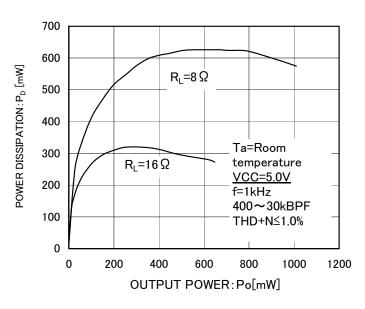


Fig.14 Power dissipation — Outpu power

100

0

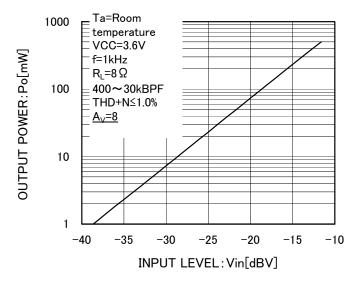


Fig.16 Output Power - Input level

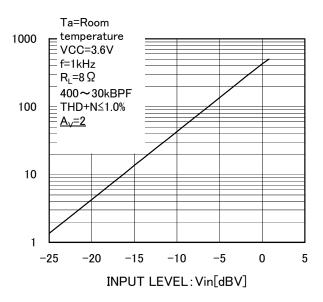


Fig.17 Output Power - Input level

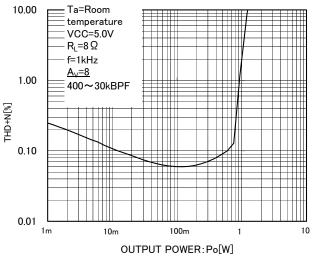


Fig.18 THD + Noise — Output Power

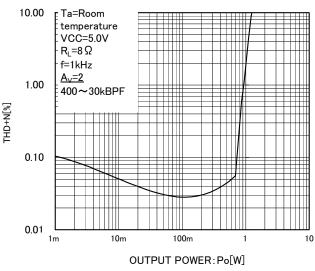
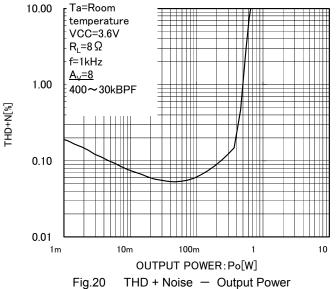
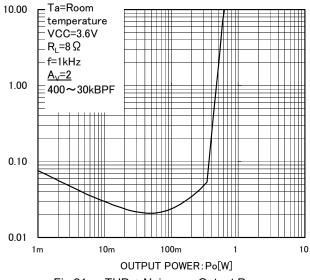


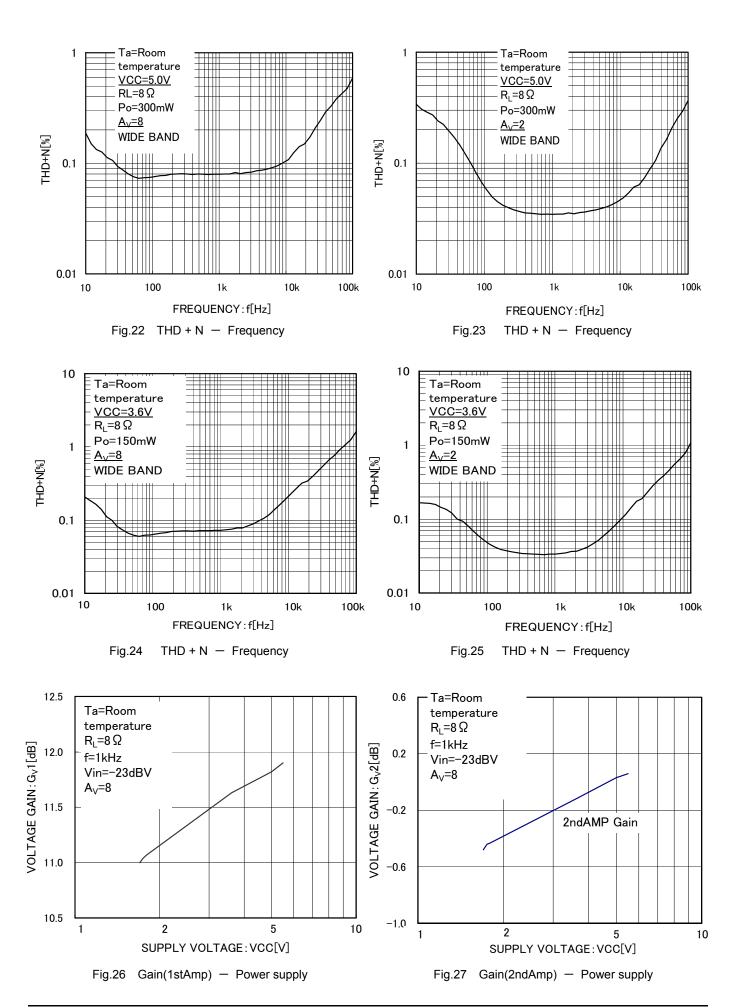
Fig.19 THD + Noise — Output Power



THD + Noise — Output Power



THD + Noise — Output Power Fig.21



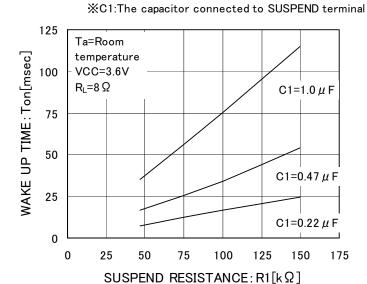


Fig.28 Wake up time - SUSPEND terminal resistance

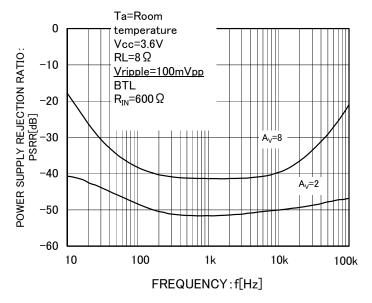
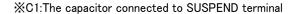


Fig.30 Power Supply Rejection Ratio — Frequency



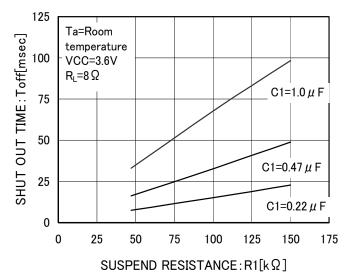


Fig.29 Shut out time - SUSPEND terminal resistance

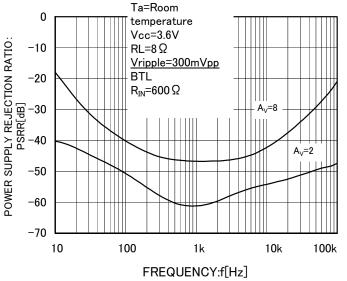


Fig.31 Power Supply Rejection Ratio — Frequency

#### Notes for use

- 1) Numbers and data in entries are representative design values and are not guaranteed values of the items.
- 2) Although ROHM is confident that the example application circuit reflects the best possible recommendations, be sure to verify circuit characteristics for your particular application. Modification of constants for other externally connected circuits may cause variations in both static and transient characteristics for external components as well as this Rohm IC. Allow for sufficient margins when determining circuit constants.
- 3) Absolute maximum ratings

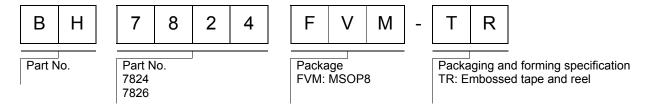
Use of the IC in excess of absolute maximum ratings, such as the applied voltage or operating temperature range (Topr), may result in IC damage. Assumptions should not be made regarding the state of the IC (short mode or open mode) when such damage is suffered. A physical safety measure, such as a fuse, should be implemented when using the IC at times where the absolute maximum ratings may be exceeded.

4) GND potential

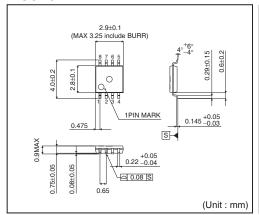
Ensure a minimum GND pin potential in all operating conditions. Make sure that no pins are at a voltage below the GND at any time, regardless of whether it is a transient signal or not.

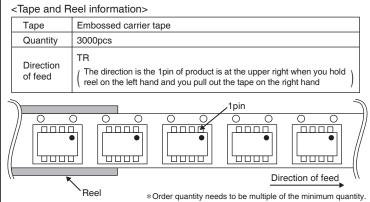
- 5) Thermal design
  - Perform thermal design, in which there are adequate margins, by taking into account the permissible dissipation (Pd) in actual states of use.
- 6) Short circuit between terminals and erroneous mounting Pay attention to the assembly direction of the ICs. Wrong mounting direction or shorts between terminals, GND, or other components on the circuits, can damage the IC.
- Operation in strong electromagnetic field
   Using the ICs in a strong electromagnetic field can cause operation malfunction.

# Ordering part number



# MSOP8





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JAPAN	USA	EU	CHINA
CLASSⅢ	CLASSⅢ	CLASS II b	CL ACCIII
CLASSIV	CLASSIII	CLASSⅢ	CLASSII

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  - [f] Sealing or coating our Products with resin or other coating materials
  - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
  - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
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- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation (Pd) depending on Ambient temperature (Ta). When used in sealed area, confirm the actual ambient temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

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